



Industrial X-ray
and CT



X-ray and
CT technology for
electronics inspection

XT V SERIES

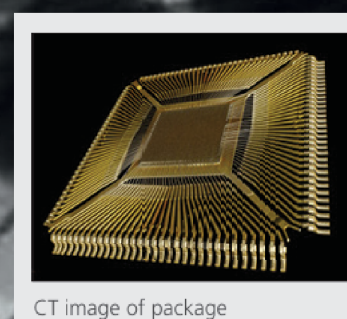
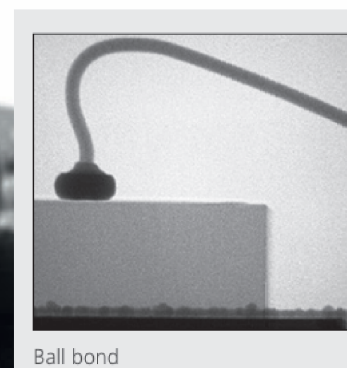
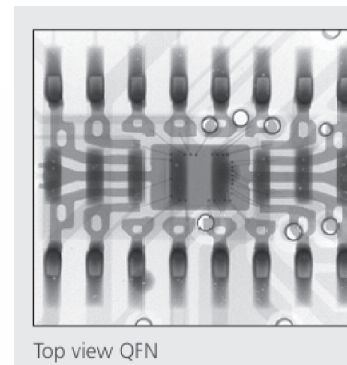
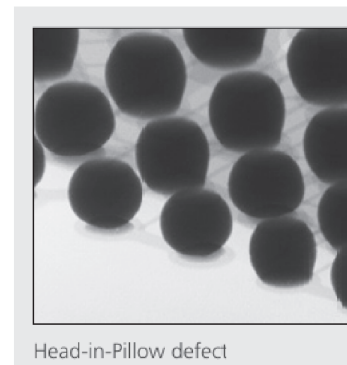
Electronics inspection made easy

There is an increasing demand for flexible, high-resolution and cost-effective X-ray inspection systems to cope with the evolution of ever-shrinking geometries within electronics components and to comply with tighter quality standards.

The XT V series enable insights into printed circuit board assemblies, components, or electrical devices in an intuitive, non-destructive inspection process. X-ray inspection provides many benefits to manufacturers and researchers, accelerating throughput and improving product quality whilst reducing costs.

A wealth of applications

With the constant demand for component miniaturization and 3D packaging technologies, modern X-ray inspection systems must provide the sharpest images and a vast range of applications in order to increase productivity.



SMD (SURFACE MOUNT DEVICES)

BGA (Ball Grid Array)	- BGA diameter and circularity
QFN (Quad-Flat No-leads)	- BGA and PAD array void analysis
QFP (Quad Flat Package)	- Head-in-Pillow
	- Cold or dry joint
	- Missing BGA
	- Bridging
	- Form solder connection
	- Solder balls

THROUGH-HOLE

- Filling of PTH
- Cracks in through holes
- Bridging between pins

IC BONDING

Wire bonding (Au or Cu)	- Broken wire
Flip chip	- Wire sweep analysis
C4 (Controlled Collapse Chip Connection)	- Broken wedge bond
	- Lifted ball bond
	- μ BGA void analysis
	- Cold joint
	- Package void analysis

WAFER LEVEL INTERCONNECTIVITY: WLFP OR WL-CSP, 3D PACKAGING, SYSTEM IN PACKAGE (SIP)

TSV (Through Silicon Via)	- Voids in Cu filling
Micro-bumps	- Remaining edge fluid
Cu-pillar	- Voids analysis
	- Cold joint

Besides electronics inspection, XT V systems are also suited for X-ray and CT inspection of a wide variety of smaller components. The large tray can hold different samples for serial NDT analysis:

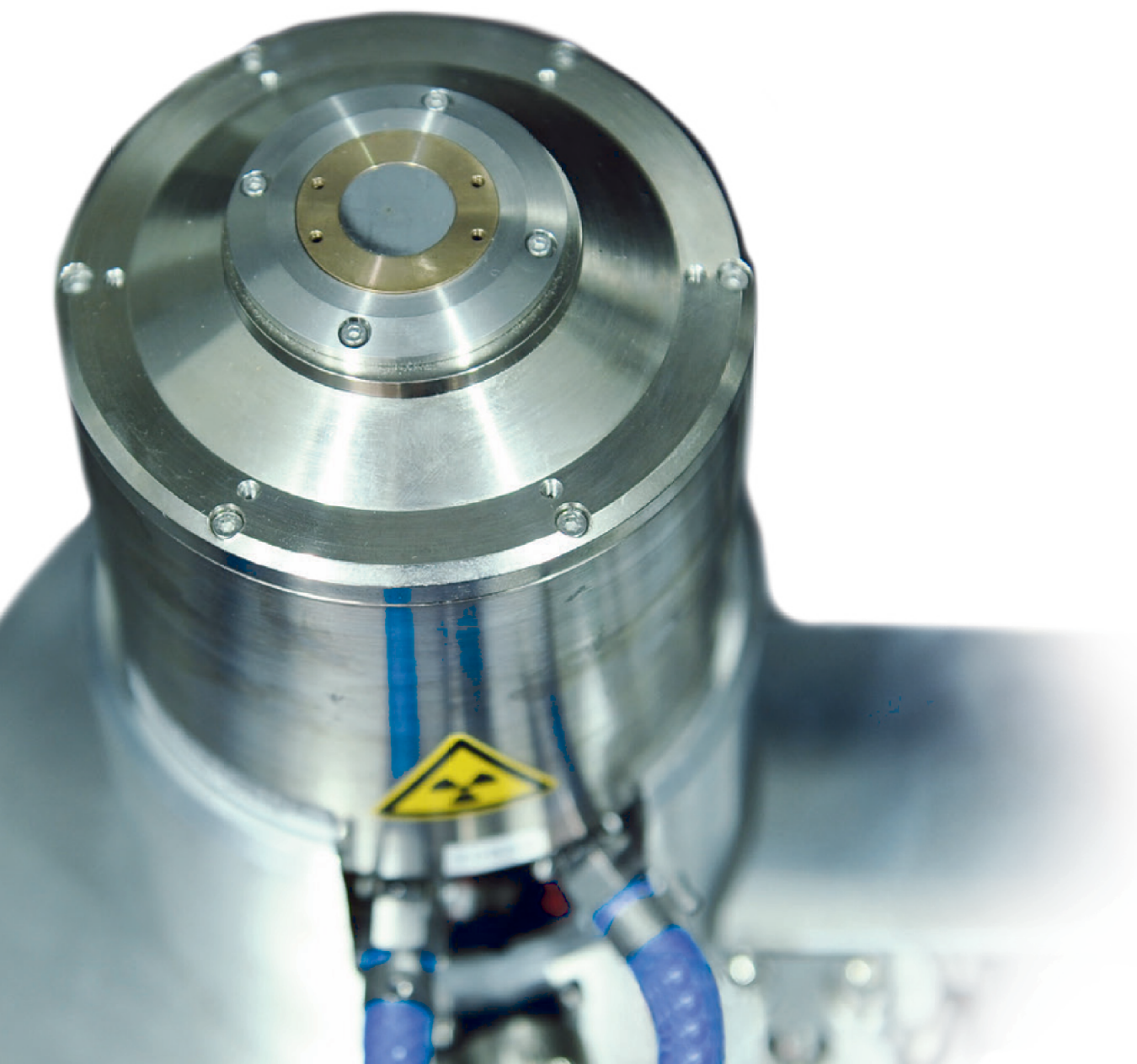
Micro-Electro-Mechanical Systems (MEMS, MOEMS) often used in consumer electronics such as smartphones, these can include accelerometers, pressure sensors, gyroscopes, action buttons, etc.

Series radiographic inspection of small components such as cables, harnesses, plastic parts, LED lights, switches, medical parts, etc.

At the core of X-ray technology

Nikon Metrology X-ray sources are the core of our technology and are designed and manufactured in-house. This allows Nikon Metrology to quickly move with the market and develop complete and innovative solutions to the application demand.

Key benefits include low cost of ownership, lower maintenance and higher reliability through open tube design. The integrated voltage generator eliminates the need for a high voltage cable assembly that requires regular maintenance.



With inherent precision

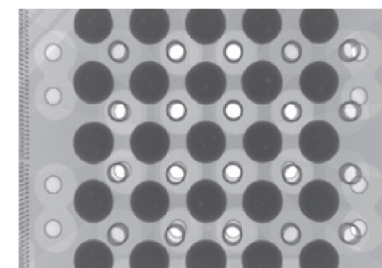


The XT V systems are supplied with a highly accurate sample manipulator with an optional precision CT rotate axis.

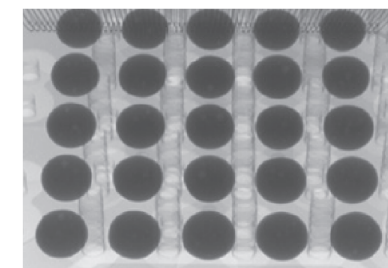
The vertical system configuration, with the X-ray tube below the sample holder and the tilting imager is controlled through user-friendly Inspect-X software or via precise joystick manipulation.

Capable of multiple rotations even at maximum tilt, the rotate table of the premium XT V 160 provides helicopter fly-around views of any region of interest even at maximum magnification.

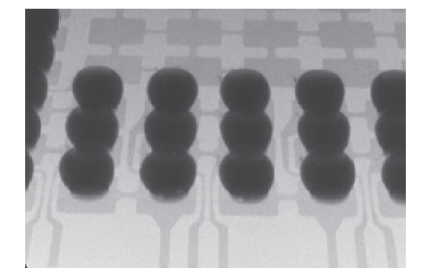
0°



45°



72°



Tilt angles up to 72° offers sufficient flexibility to trace connectivity

Real-time inspection with advanced analysis

Interactive and user-friendly software is essential in evaluating the complex internal structures, performing accurate inspection, providing defect recognition with confidence.

Inspect-X has been designed around the user experience, resulting in intuitive and productive X-ray inspection. Inspect-X features user friendly wizards to guide users through complex inspections, as well as utilizing the most advanced visualization and analysis function capabilities. XT V systems with Inspect-X enable rapid deployment of new product lines, within minutes, rather than hours or days.

INSPECT-X CONTROL SOFTWARE

- Workflow based – all necessary controls available to the user's workflow
- Various user access levels for supervisors and operators
- Quick access toolbar to most applicable functions
- Minimum training time
- Board map for quick sample overview
- Collision avoidance between all components of the system and sample
- All functions included as standard; no add-on modules required

REAL TIME X-RAY INSPECTION

- On-screen joysticks and mouse gestures, as well as conventional intuitive joystick control, for interactive live part positioning
- Variable magnification and tilted viewing angle allow real time detection of defects such as head-in-pillow.
- Magnification, tilt and rotate in all positions whilst maintaining a region of interest consistently locked into the center of the field of view
- C.Clear imaging engine provides crystal-clear live images
- Real-time imager for interactive visualization

HIGH-CONTRAST FILTER, POWERFUL IMAGE ENHANCEMENT

High-Contrast Filter enables operators to identify defects quickly and with confidence. Compared to standard filters, which risk overexposing lower-density areas when visualizing defects in high-density areas, the filter normalizes the contrast across the whole image, revealing details in both high and low-density areas in a single clear image. As a result, time-consuming enhancements dedicated to specific areas of the image are not required.

When performing an interactive live visual inspection, C.Clear intelligently adapts and adjusts the image processing parameters in real-time, to facilitate defect recognition in the live image, by a novice operator.

Raw radiograph



With High-Contrast Filter

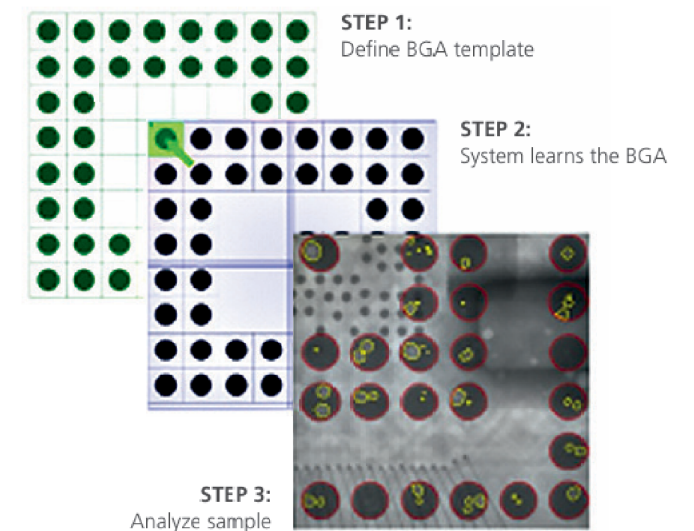
BGA DEVICE INSPECTION

The BGA device inspection functionality is an 'all-in-one' tool offering automatic analysis of:

- Voiding (single and total ball percentage)
- Ball circularity
- Ball count
- Bridging
- Pass/Fail detection

With its powerful image processing algorithm, the tool gives accurate results even in complex board assemblies with underside components.

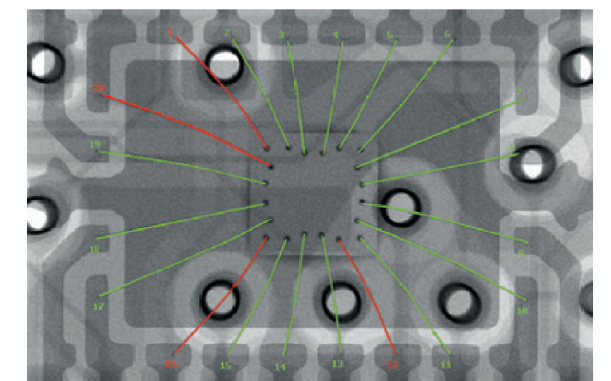
The tool allows creation of an internal library of BGA templates using a wizard or via file import to reduce the time taken to build automated pass/fail inspection routines.



BOND WIRE ANALYSIS

Featuring high magnification and (sub)micron feature detection, the XT V platforms equipped with Inspect-X are a powerful tool for advanced bond wire inspection. The new automated multi-bond wire tool provides repeatable inspection with the highest accuracy.

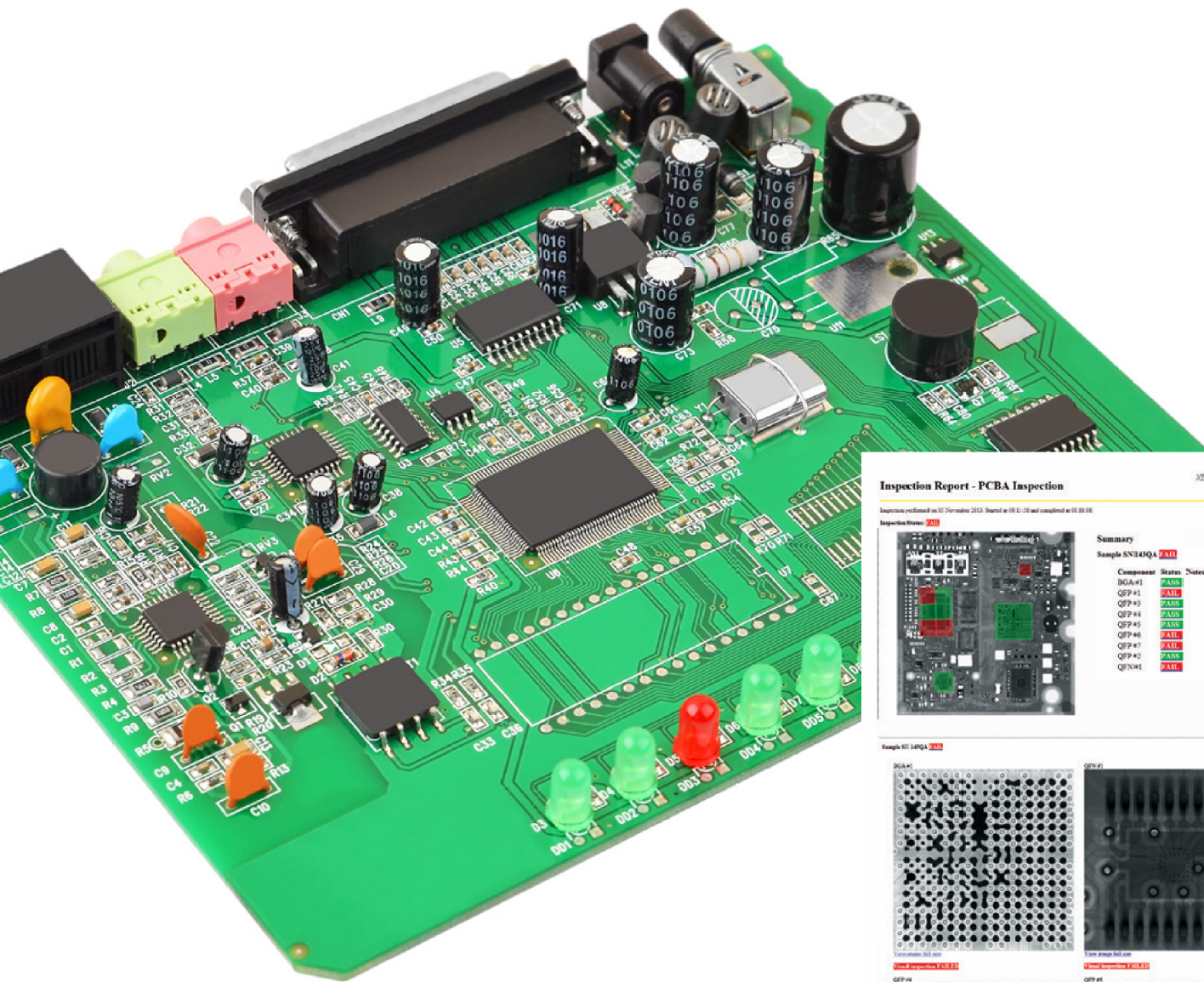
- Identify and detect broken bond wires and wire sweep with pass/fail status
- Automatically analyze multiple bond wires on a device in a single inspection
- Component templates can be saved to an internal library, aiding rapid future builds of inspection routines.



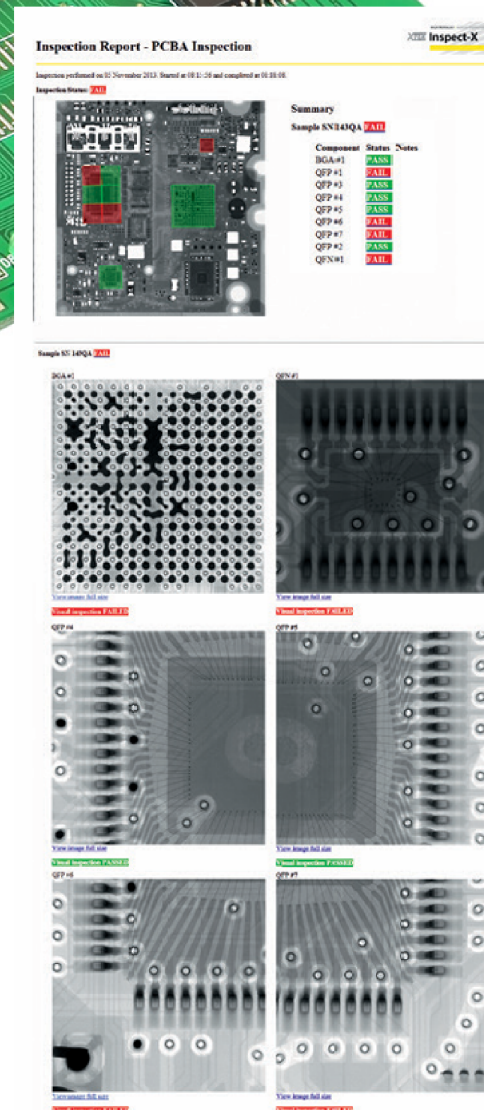
Bond wire analysis



Insightful reporting



Inspect-X provides a suite of easy-to-use tools and customizable HTML templates for endless real-time or automated reporting possibilities. Reports can be easily shared with colleagues or suppliers to facilitate decision-making. Results are available for offline analysis and troubleshooting on validation station.



Focusing on productivity

Operating in automated inspection mode, the XT V combined with Inspect-X is a productive X-ray solution for repeated inspection of PCBAs, semiconductor components and complex high-density boards. Creation and execution of inspection routines is straightforward, utilizing the graphical interface or teach and learn. Users requiring detailed insight of (multi-layer) electronic components can benefit from the X.Tract or Computed Tomography functionality for a full 3D view of internal structure.

AUTOMATED INSPECTIONS

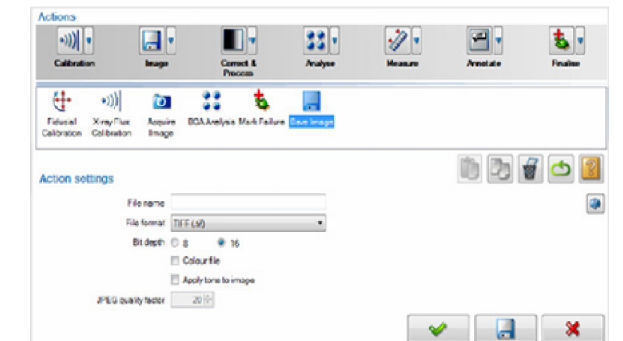
- Macros for automating simple repetitive tasks
- Automated inspection and analysis of full boards or multiple components
- No programming skills required, utilizing graphical interface or teach and learn
- Intelligent Program Control (IPC) for customizable system control
- Off-line validation station giving maximum efficiency of the X-ray system
- HTML reporting function, readable on any PC with no special software
- Switch seamlessly between radiographic (2D) and CT (3D) modes in one single software
- Visual check during automated inspection allows interactive inspection

SEE MORE WITH X.TRAC

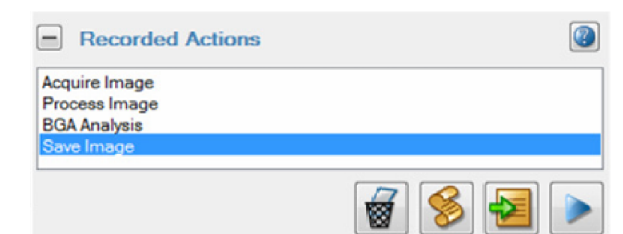
X.Tract provides CT-quality inspection results of complex, multi-layer electronics assemblies without slicing them. In a rapid and user-friendly process, it enables virtual micro-sections in any direction in the region-of-interest. X.Tract reveals defects that are obscured in 2D X-ray images of complex components such as Package on Package (PoP) or double sided boards. With X.Tract, users gain better insights leading to reduced false call rates and higher productivity.

READY FOR CT

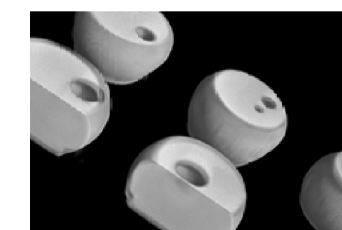
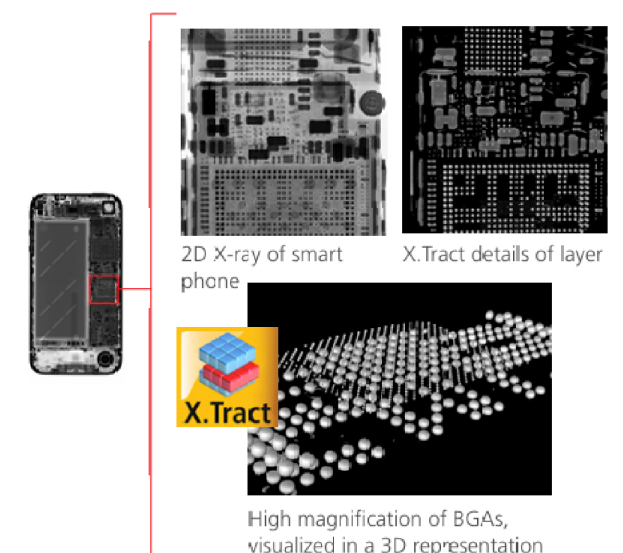
- CT acquisition and analysis as factory option or field upgrade
- Easy, user guided, CT data collection
- Fast Rescan – rescan in only two steps
- World-leading reconstruction times
- Automatic reconstruction of CT data streamed from XT V system
- Powerful CT analysis in the software of your choice



Intuitive icons help the user to interactively build an automated inspection routine



Macro-based recording enables the user to program for repeated inspection or batch analysis



Voids in BGA (CT image)

Specifications

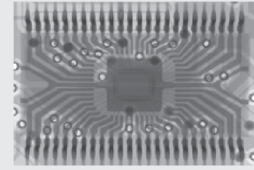
INTUITIVE TO USE

- Intuitive joystick navigation for real-time X-ray inspection
- Collision-free sample manipulation
- Large 30" display for combined system control and real-time analysis
- Industry leading Inspect-X software
- Minimum training requirement - operational within 1 day
- Local language support

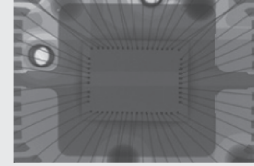
HIGH-QUALITY IMAGES

- In-house designed and manufactured microfocus sources
- Up to 2,046x geometric magnification to zoom in on the smallest details
- 500 nm feature recognition on XT V 160
- 16bit image processing
- Max 72° tilt angle to detect cold joints and head-in-pillow
- Accurate control of the power and direction of the emitted X-ray beams

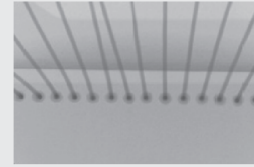
5.30x



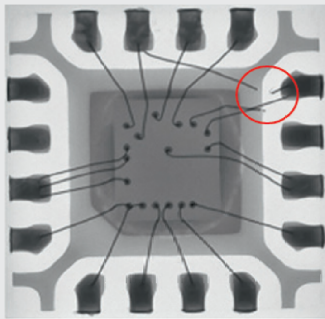
16.7x



150x



Unparalleled magnification, enables users to zoom in on any region of interest.



Broken bond wire

FOCUS ON PRODUCTIVITY

- Fast automated component inspection with immediate analysis and reporting
- Load position for quick and easy loading/unloading of sample
- Large door with automatic interlocked X-ray off function provides easy access to the inspection area
- Large tray to load multiple boards
- Barcode reader for automatic recognition of specimen serial number (optional)

LOW COST OF OWNERSHIP

- Unlimited source life-time due to open tube design with user replaceable low cost filaments
- Serviceable components are easily accessible
- Integrated source requires no high voltage cable
- No special floor treatment required

SAFETY AS A DESIGN CRITERION

- Continuous fail-to-safe monitoring
- Full protective enclosure requires no special badges or protective clothing
- Lead-lined cabinet fully complies to D/N 54113 radiation safety standards and CE regulation



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